

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of

Sang Hyun YI et al

Serial No.

Filed: January 4, 2002

For: SEMICONDUCTOR DEVICE HAVING NO CRACKS IN ONE OR MORE  
LAYERS UNDERLYING A METAL LINE LAYER AND METHOD OF  
MANUFACTURING THE SAME

**PRELIMINARY AMENDMENT**

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

Prior to initial examination on the merits, please amend the application identified  
above as follows:

**IN THE DRAWINGS**

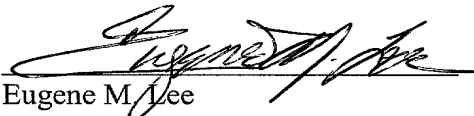
Kindly substitute the attached sheet "3/17" depicting Figures 3A and 3B for the sheet  
designated "3/17" appended to the application. Figure 3A, second occurrence on this sheet of  
drawing, has been corrected to read — — Fig. 3B — —.

**REMARKS**

This drawing amendment is presented to correct an obvious clerical error.

Respectfully submitted,

January 4, 2002  
Date

  
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FIG.3A BACKGROUND ART

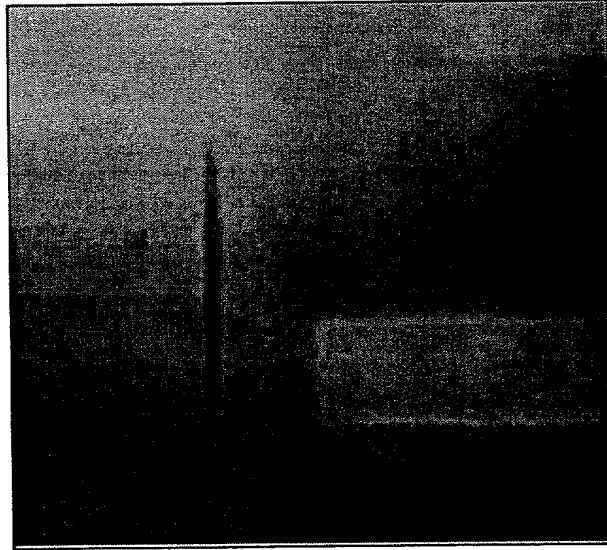


FIG.3B BACKGROUND ART

